

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Song-Hua Shi et al.

Title: UNDERFILL PROCESS FOR FLIP-CHIP DEVICE

Docket No.: 2827.035US2

Serial No.: 10/774,869

Filed: February 9, 2004

Due Date: June 25, 2008

Examiner: Junghwa M. Im

Group Art Unit: 2811

**MS AF**

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

We are transmitting herewith the following attached items (as indicated with an "X"):

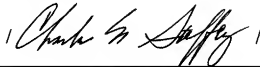
X Amendment and Response Under 37 CFR 1.116 (5 pgs.).

If not provided for in a separate paper filed herewith, Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

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(GENERAL)